EDPS Innovation Scholarship Program 2024-25

The EDPS Innovation Scholarship Program 2024-25 has been launched in December 2024. A total of 60 scholarships will be offered in the next 3 school years (2024-2027; 20 for each year) to undergraduate students in their last year of local university with a major in Data Science/Computer Science/IT to recognise their academic accomplishments.

Award Value	Individual Scholarships: HKD$20,000 each Group Scholarships: HKD$30,000 (shared equally between the group applicants in a single application)
Eligibility	Applicants who are a full-time student and enrolled in one of the local universities in Hong Kong can be considered for the Individual Scholarships and the Group Scholarships. Applicants shall include innovative projects using emerging technologies in the following areas: - Artificial Intelligence & Machine Learning - Artificial Intelligence in Healthcare - Blockchain, FinTech & Web3 - Cyber Security - Metaverse & Extended Reality (AR, VR & MR)
Application Deadline	15 March 2025 (Saturday)
Details	Scholarships applicants must meet all requirements for the EDPS Innovation Scholarship Program. Applicants are expected to submit their applications via the EDPS Scholarship Portal. Further details can be found Here.
Enquiry	Mr Oscar Lam Assistant Event Project Manager Email: oscarlam@edps.com.hk